



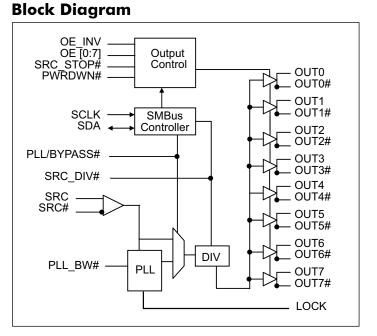
1:8 Clock Driver for Intel PCI Express[®] Chipsets

Features

- → Eight Pairs of Differential Clocks
- → Low skew < 50ps
- → Low Cycle-to-cycle jitter < 50ps
- → Output Enable for all outputs
- → Outputs Tristate control via SMBus
- → Power Management Control
- → Programmable PLL Bandwidth
- → PLL or Fanout operation
- → 3.3V Operation
- → 100-200 MHz PLL Mode Operation
- → 100-400 MHz Bypass Mode Operation
- → Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- → Halogen and Antimony Free. "Green" Device (Note 3)
- → For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/
- → Packaging (Pb-Free & Green):
 - 48-Pin SSOP (V)

Description

PI6C20800 is a high-speed, low-noise differential clock buffer designed to be a companion to PI6C410B. The device distributes the differential SRC clock from PI6C410B to eight differential pairs of clock outputs either with or without PLL. The input SRC clock can be divided by 2 when SRC_DIV# is LOW. The clock outputs are controlled by input selection of SRC STOP#, PWRDWN# and SMBus, SCLK and SDA. When input of either SRC_STOP# or PWRDWN# is LOW, the output clocks are Tristated. When PWRDWN# is LOW, the SDA and SCLK inputs must be Tristated.



Notes:

^{1.} No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

^{2.} See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

PI6C20800 Document Number DS43444 Rev 1-2





Pin Configuration

SRC_DIV#			V _{DD_A}
V _{DD}		47 🗖	V _{SS_A}
V _{SS}	₫ 3	46 🗖	IREF
SRC	d 4	45 🗖	LOCK
SRC#	d 5	44 🗖	OE_7
OE_0	G 6	43	OE_4
OE_3		42	OUT7
OUT0		41	OUT7#
OUT0#	d 9	40	OE_INV
VSS	[10	39	V _{DD}
V _{DD}	[] 11	38 🏳	OUT6
OUT1	[12	37 🗖	OUT6#
OUT1#	[13	36 🗖	OE_6
OE_1	[] 14	35 🗖	OE_5
OE_2	[15	34 🗖	OUT5
OUT2	[16	33 🗖	OUT5#
OUT2#	[] 17	32	V _{SS}
V _{SS}	[] 18	31	V _{DD}
V _{DD}	[19	30	OUT4
OUT3	Q 20	29	OUT4#
OUT3#	[21	28	PLL_BW#
PLL/BYPASS#	C 22	27	SRC_STOP#
SCLK	C 23	26	PWRDWN#
SDA	C 24	25	V _{SS}

Pin Descriptions

Pin #	Pin Name	Туре	Descriptions
1	SRC_DIV#	Input	3.3V LVTTL input for selecting input frequency divide by 2, active LOW.
4, 5	SRC & SRC#	Input	0.7V Differential SRC input from PI6C410 clock synthesizer
6, 7, 14, 15, 35, 36, 43, 44	OE [0:7]	Input	3.3V LVTTL input for enabling outputs, active HIGH.
40	OE_INV	Input	3.3V LVTTL input for inverting the OE, SRC_STOP# and PWRDWN# pins. When 0 = same stage When 1 = OE[0:7], SRC_STOP#, PWRDWN# inverted.
8, 9, 12, 13, 16 17, 20, 21, 29, 30, 33, 34, 37, 38, 41, 42	OUT[0:7] & OUT[0:7]#	Output	0.7V Differential outputs
22	PLL/BYPASS#	Input	3.3V LVTTL input for selecting fan-out of PLL operation.
23	SCLK	Input	SMBus compatible SCLOCK input
24	SDA	I/O	SMBus compatible SDATA
46	I _{REF}	Input	External resistor connection to set the differential output current
27	SRC_STOP#	Input	3.3V LVTTL input for SRC stop, active LOW
28	PLL_BW#	Input	3.3V LVTTL input for selecting the PLL bandwidth





Pin Descriptions Cont.

Pin #	Pin Name	Туре	Descriptions
26	PWRDWN#	Input	3.3V LVTTL input for Power Down operation, active LOW
45	LOCK	Output	3.3V LVTTL output, transition high when PLL lock is achieved (Latched output)
2, 11, 19, 31, 39	V _{DD}	Power	3.3V Power Supply for Outputs
3, 10, 18, 25, 32	V _{SS}	Ground	Ground for Outputs
47	V _{SS_A}	Ground	Ground for PLL
48	V _{DD_A}	Power	3.3V Power Supply for PLL





Serial Data Interface (SMBus)

This part is a slave only SMBus device that supports indexed block read and indexed block write protocol using a single 7-bit address and read/write bit as shown below.

Address assignment

A6	A5	A4	A3	A2	A1	A0	W/R
1	1	0	1	1	1	0	0/1

Data Protocol⁽¹⁾

1 bit	7 bits	1	1	8 bits	1	8 bits	1	8 bits	1	8 bits	1	1 bit
Start bit	Slave Addr	R/W	Ack	Register offset	Ack	Byte Count = N	Ack	Data Byte 0	Ack	Data Byte N - 1	Ack	Stop bit

Note:

Register offset for indicating the starting register for indexed block write and indexed block read. Byte Count in write mode cannot be 0. 1.

Data Byte 0: Control Register

Bit	Descriptions	Туре	Power Up Condition	Output(s) Affected	Pin
0	SRC_DIV# 0 = Divide by 2 1 = Normal	RW	1 = x1	OUT[0:7], OUT[0:7]#	NA
1	PLL/BYPASS# 0 = Fanout 1 = PLL	RW	1 = PLL	OUT[0:7], OUT[0:7]#	NA
2	PLL Bandwidth 0 = HIGH Bandwidth, 1 = LOW Bandwidth	RW	1 = Low	OUT[0:7], OUT[0:7]#	NA
3	TBD				NA
4	TBD				NA
5	TBD				NA
6	SRC_STOP# 0 = Driven when stopped 1 = Tristate	RW	0 = Driven when stopped	OUT[0:7], OUT[0:7]#	
7	PWRDWN# 0 = Driven when stopped 1 = Tristate	RW	0 = Driven when stopped	OUT[0:7], OUT[0:7]#	NA

Data Byte 1: Control Register

Bit	Descriptions	Туре	Power Up Condition	Output(s) Affected	Pin
0		RW	1 = Enabled	OUT0, OUT0#	NA
1		RW	1 = Enabled	OUT1, OUT1#	NA
2		RW	1 = Enabled	OUT2, OUT2#	NA
3	OUTPUTS enable	RW	1 = Enabled	OUT3, OUT3#	NA
4	1 = Enabled 0 = Disabled	RW	1 = Enabled	OUT4, OUT4#	NA
5		RW	1 = Enabled	OUT5, OUT5#	NA
6	-	RW	1 = Enabled	OUT6, OUT6#	NA
7		RW	1 = Enabled	OUT7, OUT7#	NA





Data Byte 2: Control Register

Bit	Descriptions	Туре	Power Up Condition	Output(s) Affected	Pin
0		RW	0 = Free running	OUT0, OUT0#	NA
1		RW	0 = Free running	OUT1, OUT1#	NA
2	Allow control of OUTPUTS with	RW	0 = Free running	OUT2, OUT2#	NA
3	assertion of SRC_STOP#	RW	0 = Free running	OUT3, OUT3#	NA
4	0 = Free running	RW	0 = Free running	OUT4, OUT4#	NA
5	1 = Stopped with SRC_Stop#	RW	0 = Free running	OUT5, OUT5#	NA
6		RW	0 = Free running	OUT6, OUT6#	NA
7		RW	0 = Free running	OUT7, OUT7#	NA

Data Byte 3: Control Register

Bit	Descriptions	Туре	Power Up Condition	Output(s) Affected	Pin
0		RW			
1		RW			
2		RW			
3		RW			
4	TBD	RW			
5		RW			
6		RW			
7		RW			

Data Byte 4: Pericom ID Register

Bit	Descriptions	Туре	Power Up Condition	Output(s) Affected	Pin
0		R	0	NA	NA
1		R	0	NA	NA
2		R	0	NA	NA
3	Daria and ID	R	0	NA	NA
4	Pericom ID	R	0	NA	NA
5		R	1	NA	NA
6		R	0	NA	NA
7		R	0	NA	NA





Functionality

PWRDWN#	OUT	OUT#	SRC_Stop#	OUT	OUT#
1	Normal	Normal	1	Normal	Normal
0	$I_{REF} \times 2$ or Float	LOW	0	$I_{REF} \times 6$ or Float	LOW

Power Down (PWRDWN# assertion)

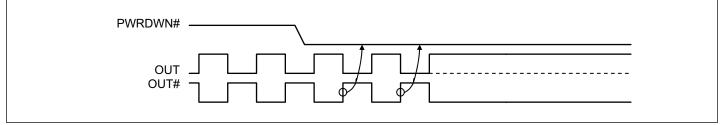


Figure 1. Power Down Sequence

Power Down (PWRDWN# De-assertion)

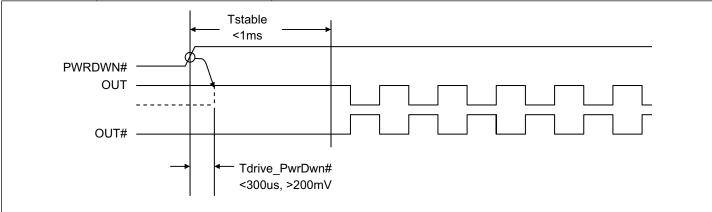
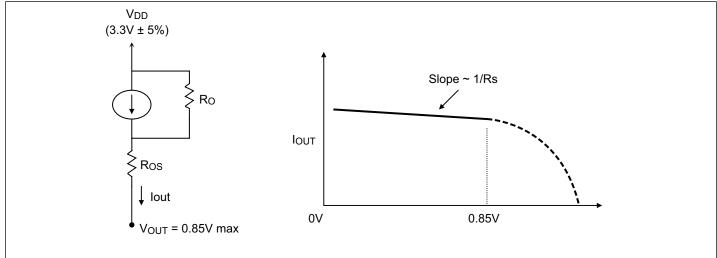


Figure 2. Power Down De-Assert Sequence

Current-Mode Output Buffer Characteristics of OUT[0:7], OUT[0:7]#









Differential Clock Buffer characteristics

Symbol	Minimum	Maximum
R _O	3000Ω	N/A
R _{OS}	unspecified	unspecified
V _{OUT}	N/A	850mV

Current Accuracy

Symbol	Conditions	Configuration	Load	Min.	Max.
I _{OUT}	$V_{DD} = 3.30 \pm 5\%$	$R_{REF} = 475\Omega \ 1\%$ $I_{REF} = 2.32mA$	Nominal test load for given configuration	-12% I _{NOMINAL}	+12% I _{NOMINAL}

Note:

 $I_{\ensuremath{NOMINAL}}$ refers to the expected current based on the configuration of the device. 1.

Differential Clock Output Current

Board Target Trace/Term Z	Reference R, Iref = V _{DD} /(3xRr)	Output Current	V _{OH} @ Z
$\frac{100\Omega}{(100\Omega \text{ differential} \approx 15\% \text{ coupling ratio})}$	$R_{REF} = 475\Omega \ 1\%,$ $I_{REF} = 2.32mA$	$I_{OH} = 6 \times I_{REF}$	0.7V @ 50





Symbol	Parameters	Min.	Max.	Units	
V _{DD_A}	3.3V Core Supply Voltage	-0.5	4.6		
V _{DD}	3.3V I/O Supply Voltage	-0.5	4.6	V	
V _{IH}	Input HIGH Voltage		4.6	v	
V _{IL}	Input LOW Voltage	-0.5			
Ts	Storage Temperature	-65	150	°C	
V _{ESD}	ESD Protection	2000		V	
TJ	Junction Temperature		125	°C	

Absolute Maximum Ratings⁽¹⁾ (Over operating free-air temperature range)

Note:

Stress beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. 1.

Symbol	Parameters	Condition	Min.	Max.	Units	
V _{DD_A}	3.3V Core Supply Voltage		3.135	3.465		
V _{DD}	3.3V I/O Supply Voltage		3.135	3.465	V	
V _{IH}	3.3V Input HIGH Voltage	V _{DD}	2.0	V _{DD} + 0.3	v	
V _{IL}	3.3V Input LOW Voltage		$V_{\rm SS}-0.3$	0.8		
I _{IK}	Input Leakage Current	$0 < V_{IN} < V_{DD}$	-5	+5	μΑ	
V _{OH}	3.3V Output HIGH Voltage	$I_{OH} = -1mA$	2.4		V	
V _{OL}	3.3V Output LOW Voltage	$I_{OL} = 1 mA$		0.4		
I _{OH} C	Output IIICII Current	$I_{OH} = 6 \times I_{REF},$	12.2		110 A	
	Output HIGH Current	$I_{REF} = 2.32 mA$		15.6	mA	
C _{IN}	Logic Input Pin Capacitance		1.5	5	"E	
C _{OUT}	Output Pin Capacitance			6	pF	
L _{PIN}	Pin Inductance			7	nH	
I _{DD}	Power Supply Current	$V_{DD} = 3.465 V, F_{CPU} = 200 MHz$		250		
I _{SS}	Power Down Current	Driven outputs		60	mA	
I _{SS}	Power Down Current	Tristate outputs		12		
T _A	Ambient Temperature		0	70	°C	

DC Electrical Characteristics (V_{DD} = 3.3±5%, V_{DD A} = 3.3±5%)





AC Switching Characteristics^(1,2,3) ($V_{DD} = 3.3\pm5\%$, $V_{DD A} = 3.3\pm5\%$)

Symbol	Parameters	Min	Max.	Units	Notes
Б	PLL Mode	100	200	MHz	
F _{IN}	Bypass Mode	100	400	MHz	
T _{rise} / T _{fall}	Rise and Fall Time (measured between 0.175V to 0.525V)	175	700		2
$\Delta T_{rise} / \Delta T_{fall}$	Rise and Fall Time Variation		125	ps	2
T _{skew}	Output-to-Output Skew		50	ps	3
V _{HIGH}	Voltage HIGH	660	850		2
V _{OVS}	Max. Voltage		1150		
V _{UDS}	Min. Voltage	-300			
V _{LOW}	Voltage LOW	-150	+150 mV		2
V _{cross}	Absolute crossing poing voltages	250	550	1	2
ΔV_{cross}	Total Variation of V _{cross} over all edges		140	1	2
T _{DC}	Duty Cycle	45	55	%	3
T _{jcyc-cyc}	Jitter, Cycle-to-cycle (PLL Mode, Measurement for differential waveform)		50	ps	
	Jitter, Cycle-to-cycle (BYPASS mode as additive jitter)				

Notes:

1. Test configuration is $R_S = 33.2\Omega$, $Rp = 49.9\Omega$, and 2pF.

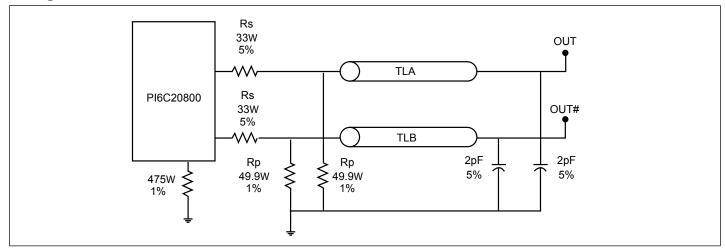
Measurement taken from Single Ended waveform. 2.

Measurement taken from Differential waveform. 3.





Configuration Test Load Board Termination



Part Marking

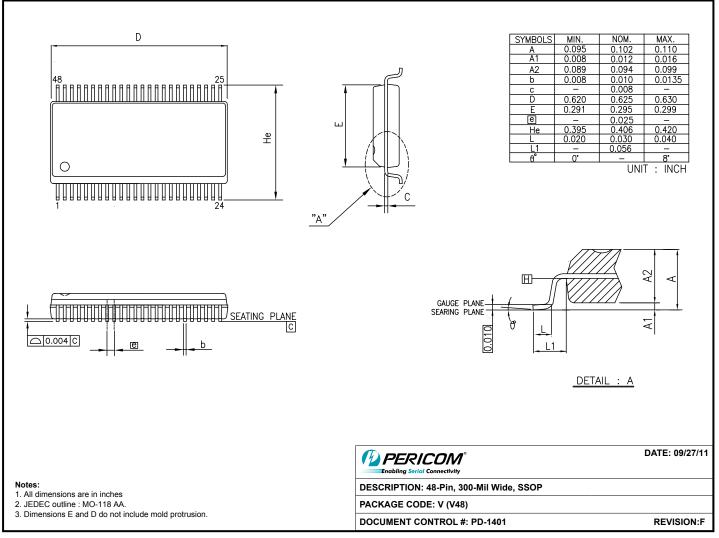


X: Die Rev YY: Year WW: Workweek 1st X: Assembly Code 2nd X: Fab Code





Packaging Mechanical: 48-SSOP (V)



11-0197

For latest package info.

please check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/

Ordering Information

Ordering Code	Package Code	Package Description
PI6C20800VEX	V	48-pin, 300-mil wide (SSOP)

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm

antimony compounds.

4. E = Pb-free and Green 5. X suffix = Tape/Reel





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